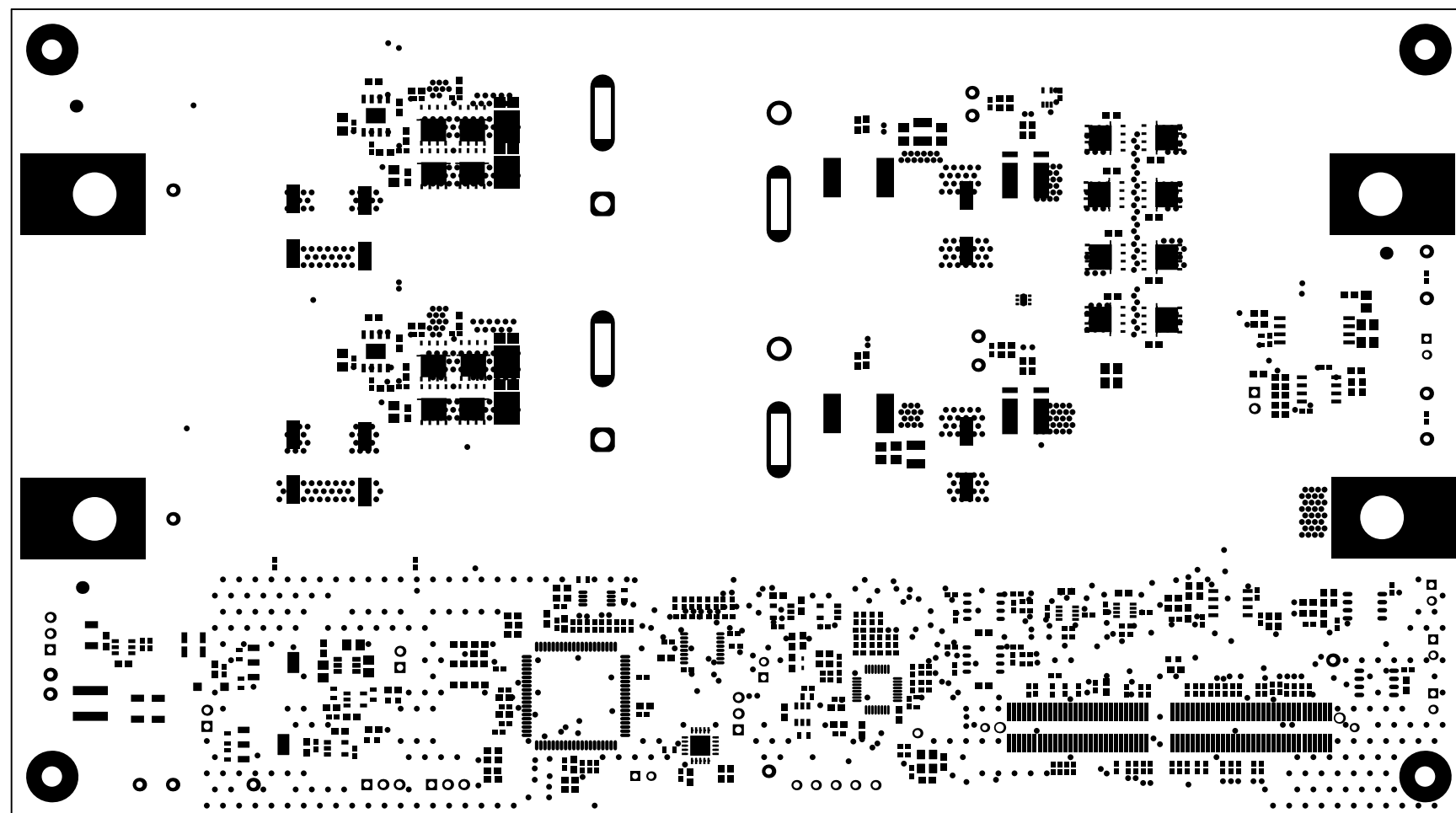
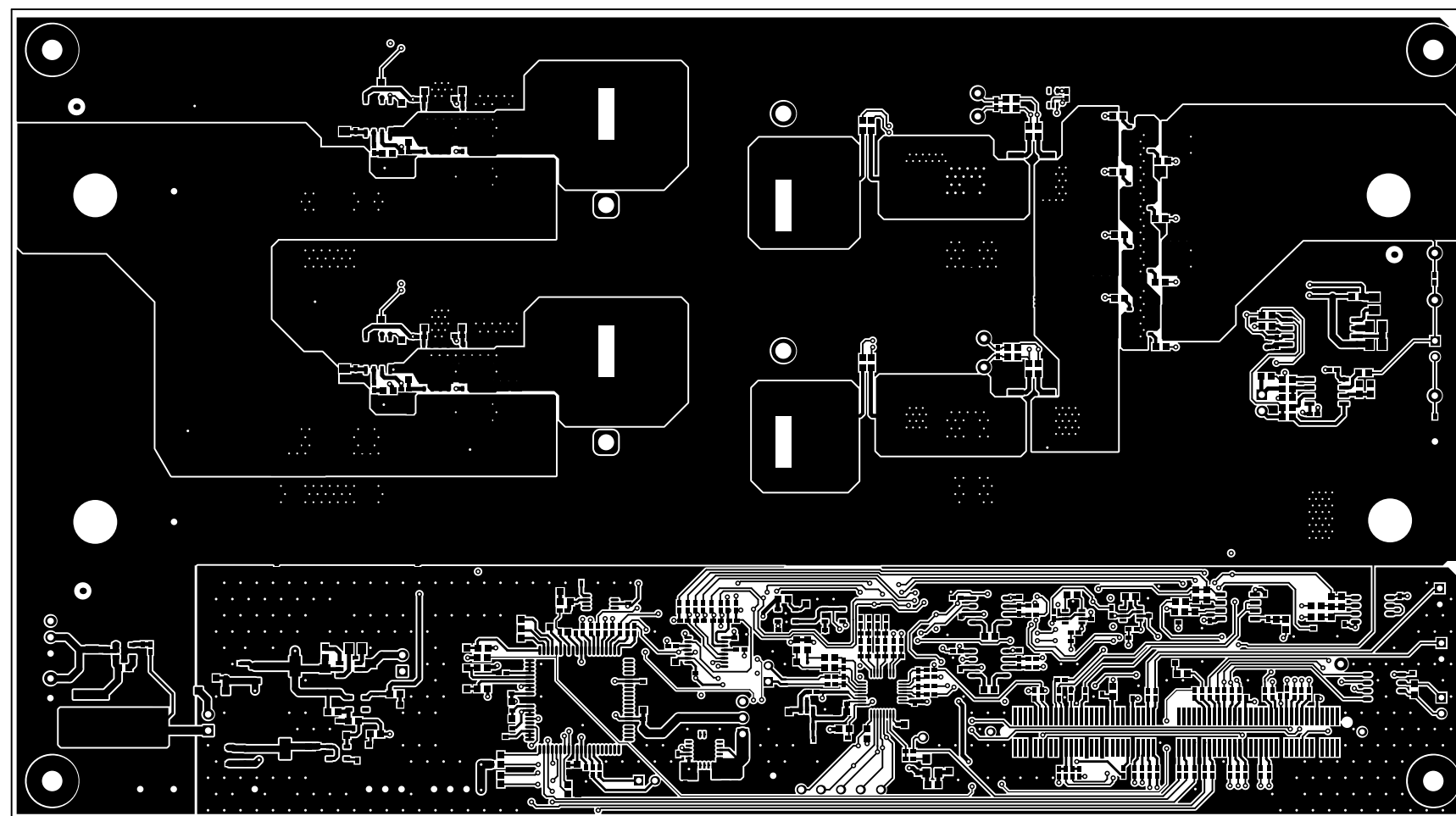


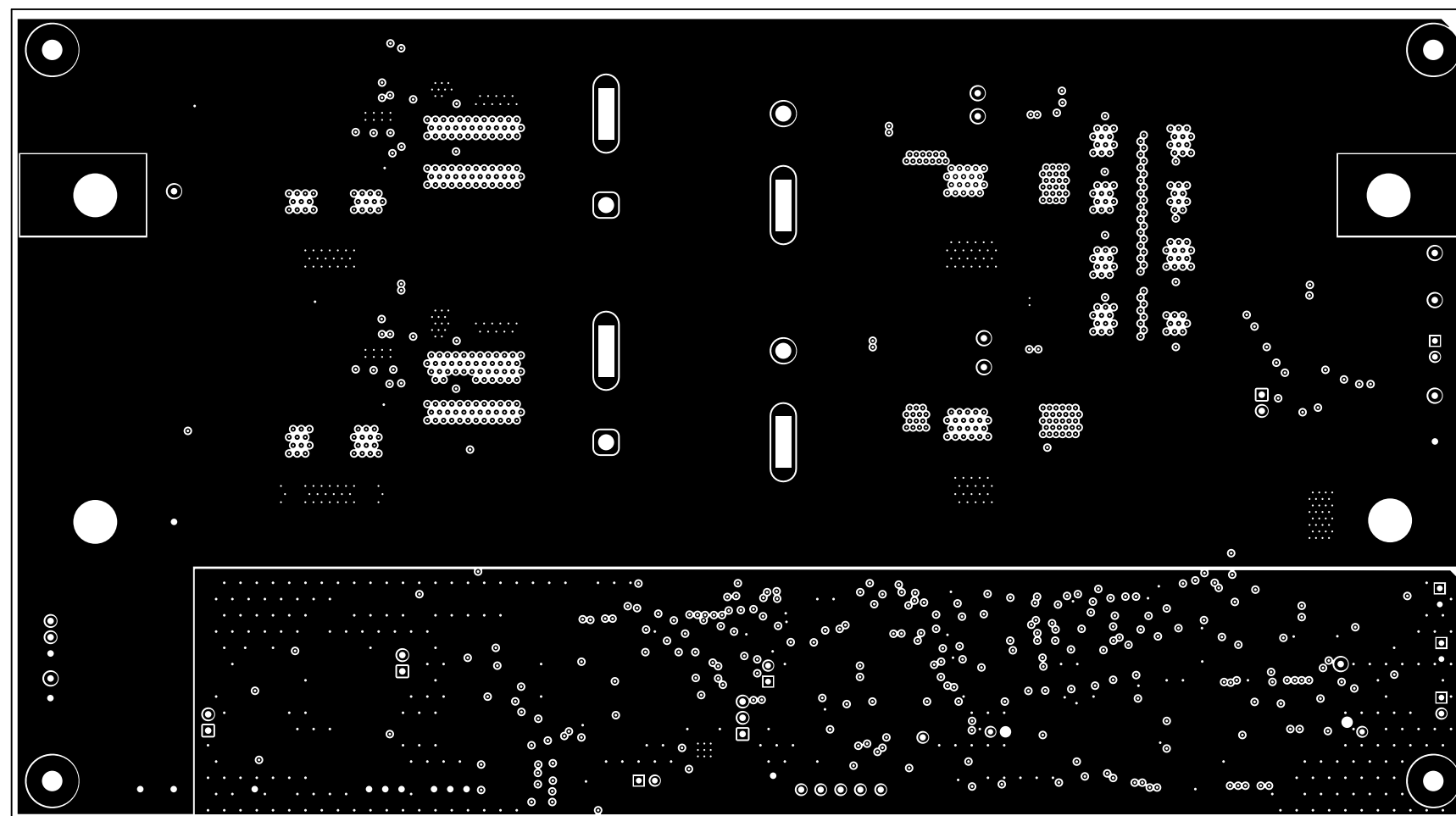
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = Top Overlay	TID #: TIDA-010087		
PLOT NAME = Top Overlay	GENERATED : 6/21/2023 8:34:17 PM	TEXAS INSTRUMENTS	



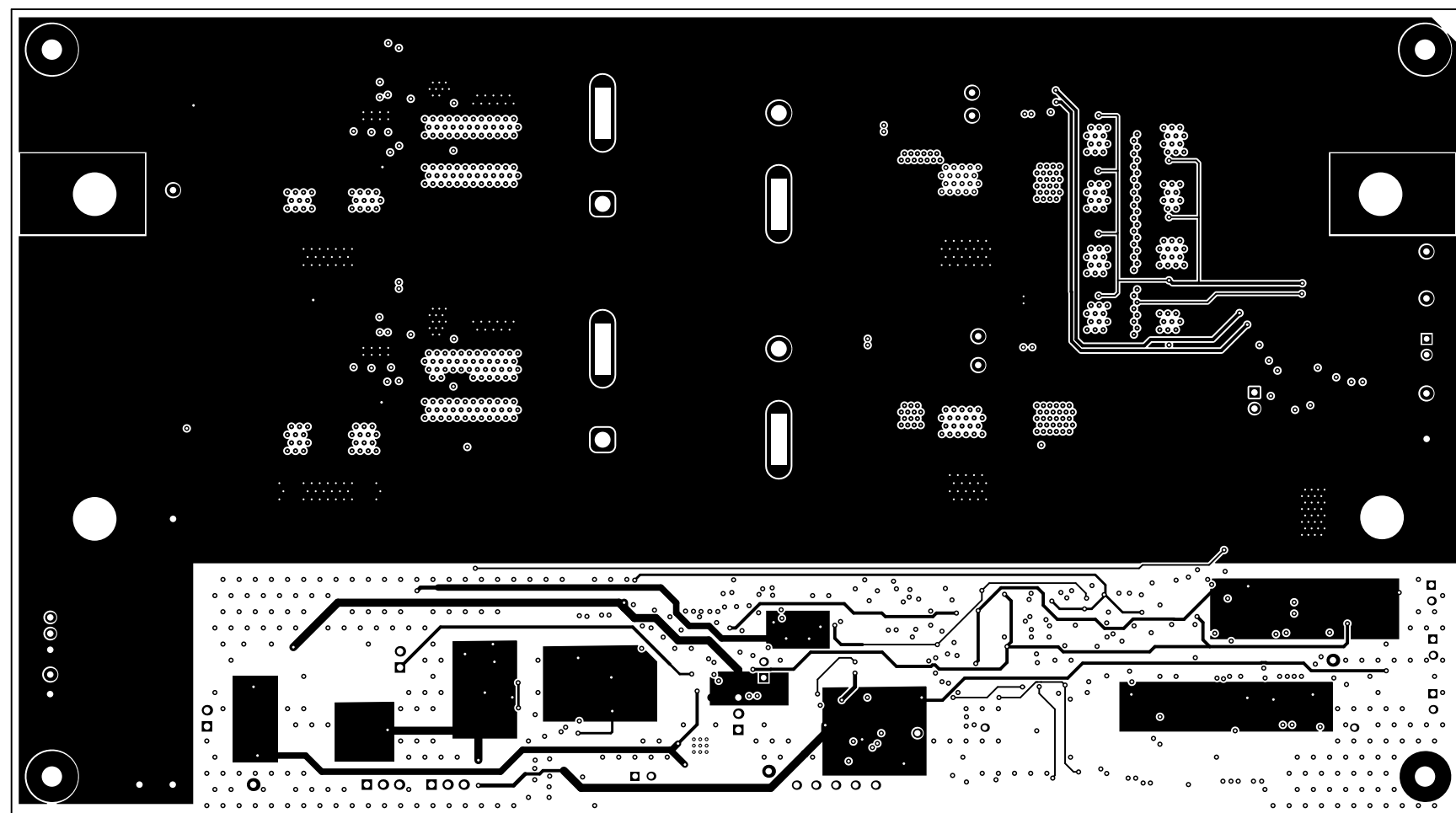
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = Top Solder	TID #: TIDA-010087		
PLOT NAME = Top Solder Mask	GENERATED : 6/21/2023 8:34:18 PM	TEXAS INSTRUMENTS	



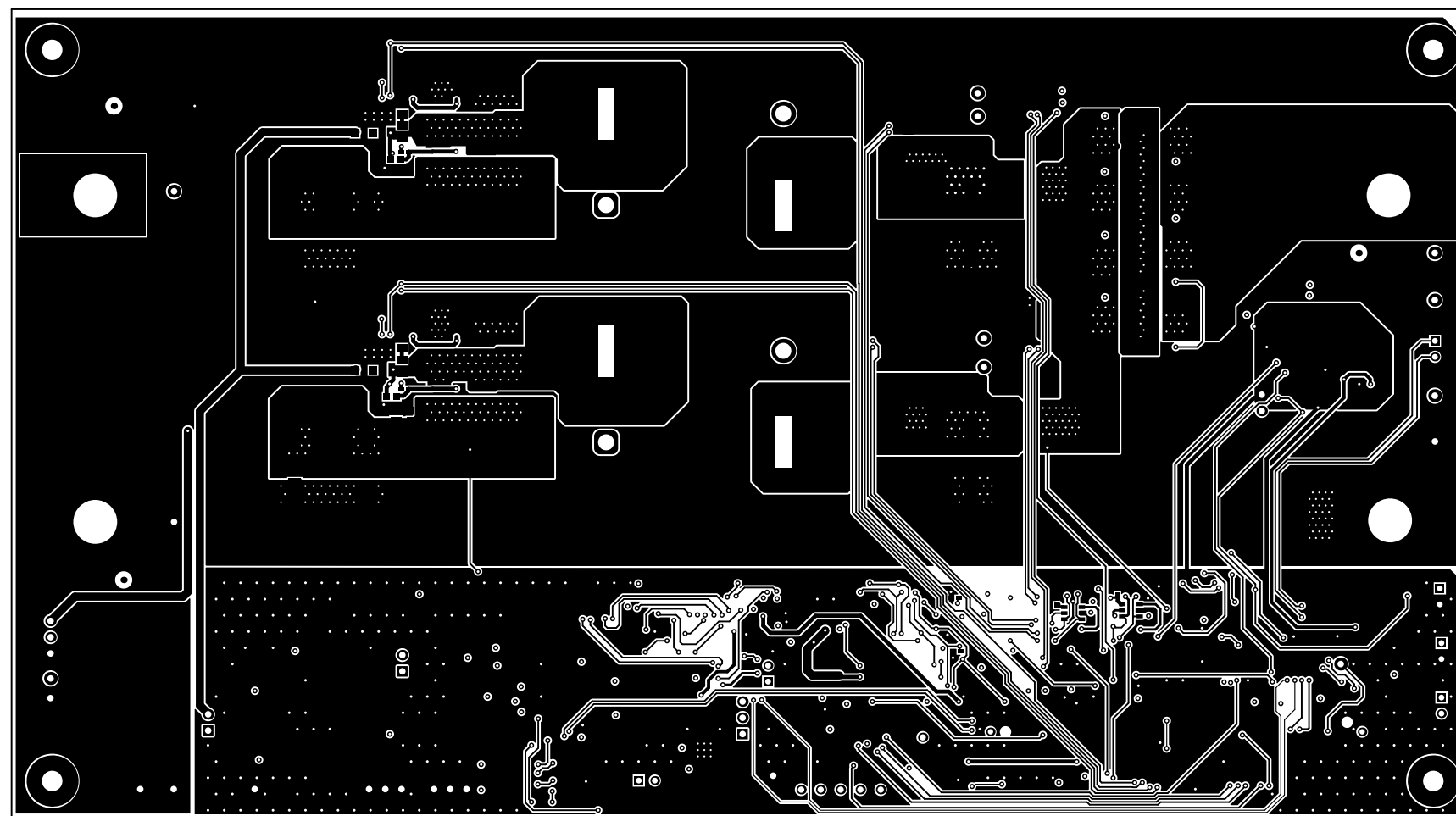
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = Top Layer	TID #: TIDA-010087		
PLOT NAME = Top Layer	GENERATED : 6/21/2023 8:34:18 PM	TEXAS INSTRUMENTS	



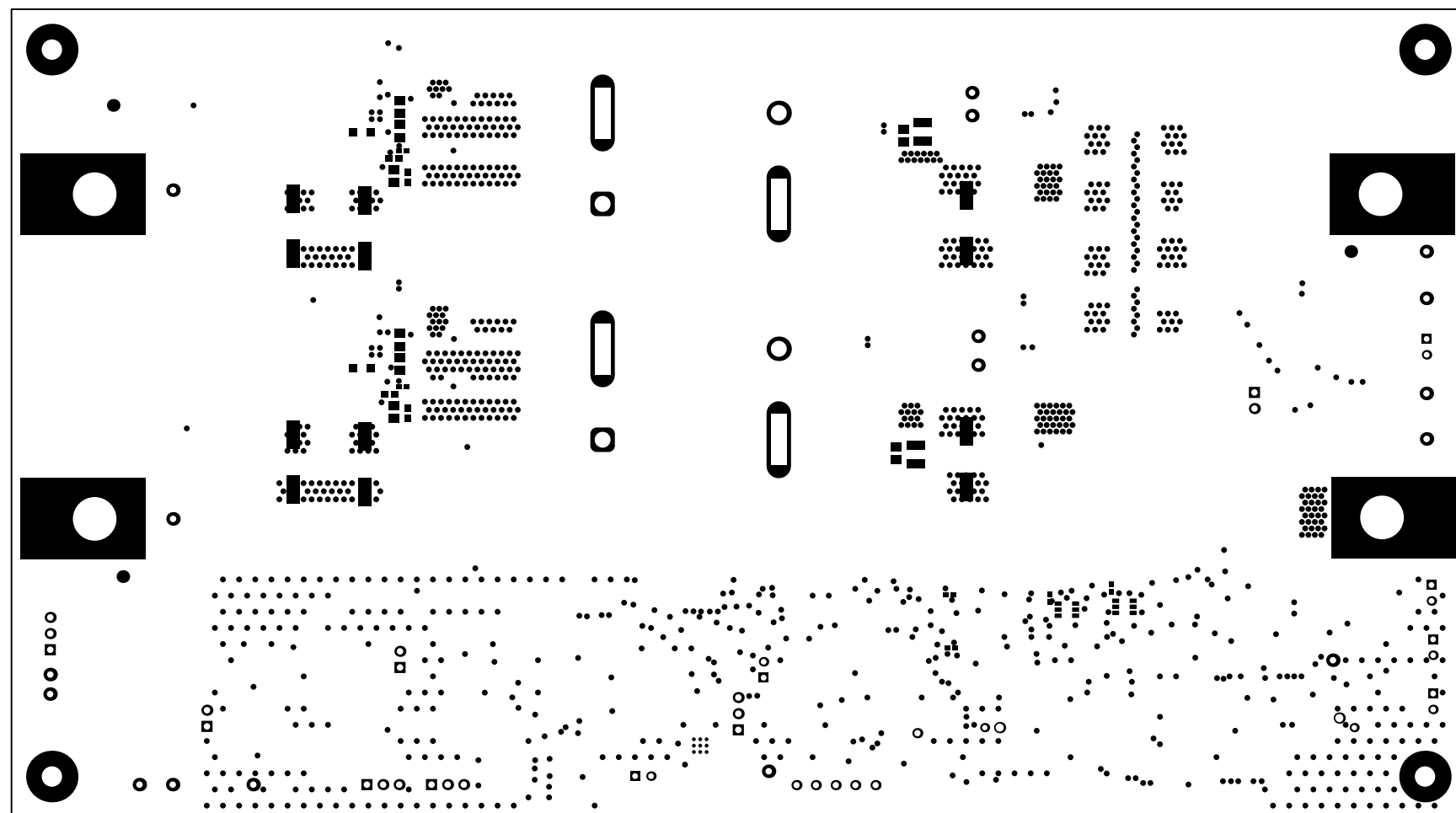
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME =	TID #: TIDA-010087		
PLOT NAME = Signal Layer 1	GENERATED : 6/21/2023 8:34:18 PM	TEXAS INSTRUMENTS	



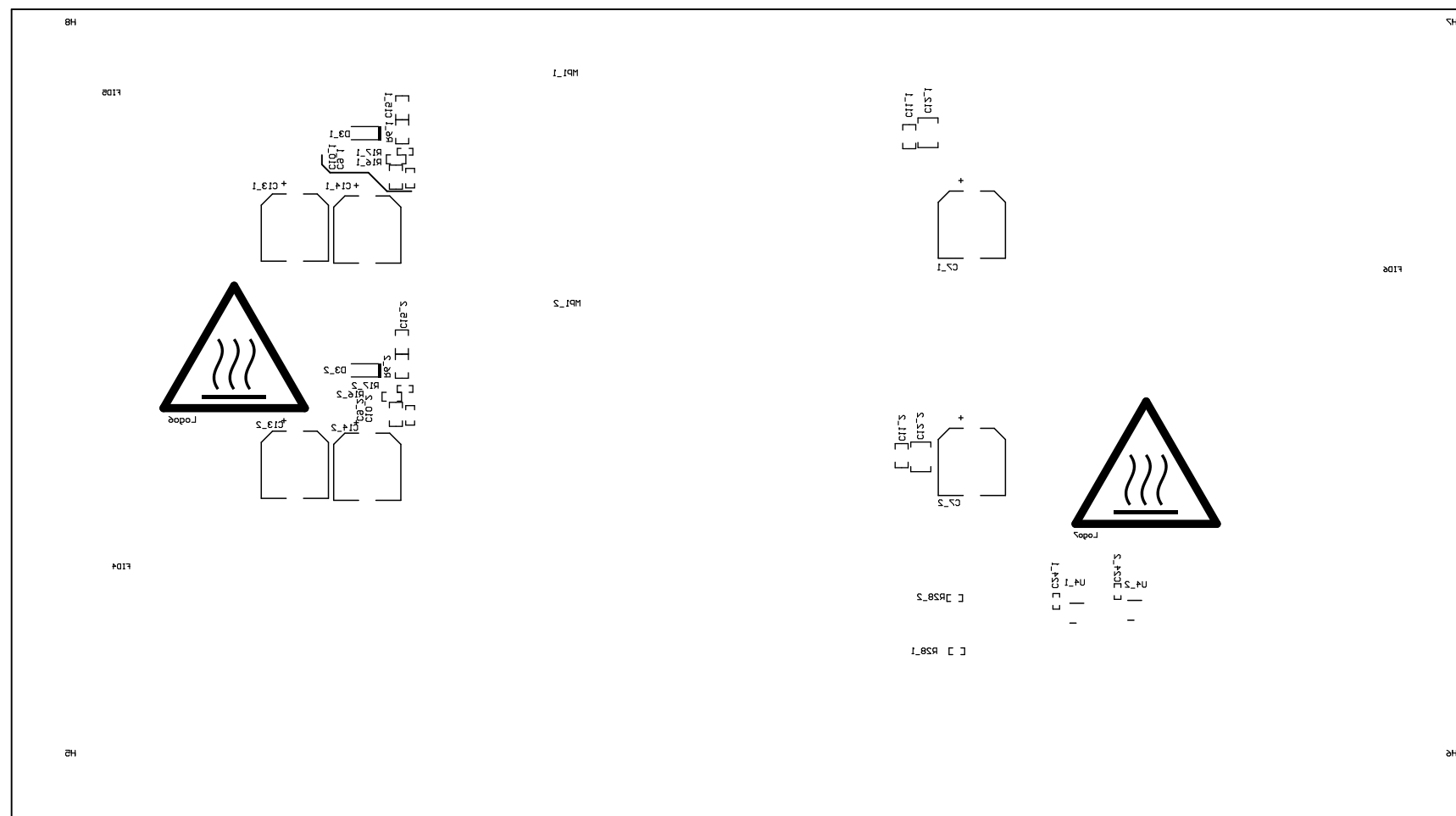
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME =	TID #: TIDA-010087		
PLOT NAME = Signal Layer 2	GENERATED : 6/21/2023 8:34:19 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = Bottom Layer	TID #: TIDA-010087		
PLOT NAME = Bottom Layer	GENERATED : 6/21/2023 8:34:19 PM	TEXAS INSTRUMENTS	



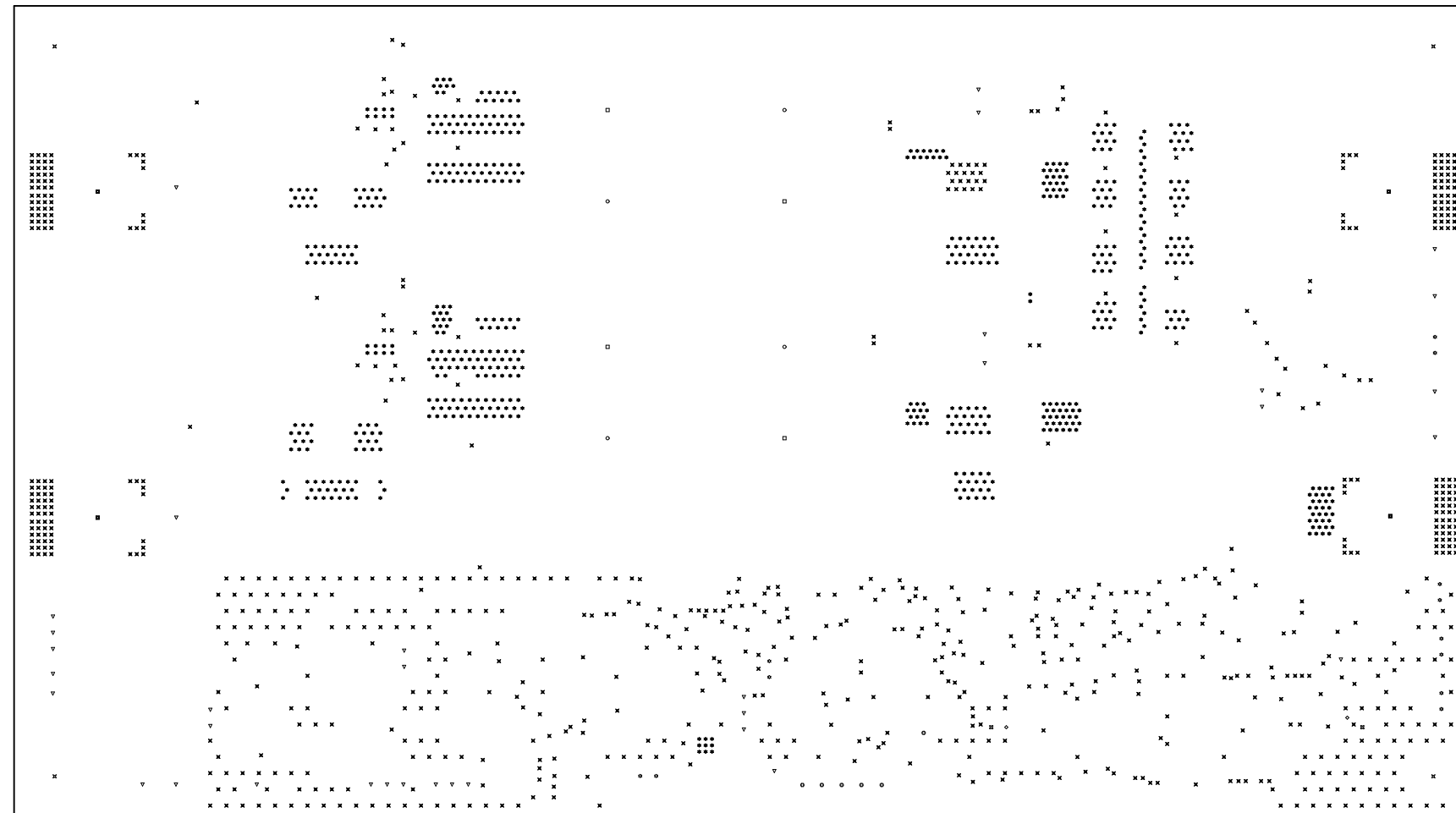
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = Bottom Solder	TID #: TIDA-010087		
PLOT NAME = Bottom Solder Mask	GENERATED : 6/21/2023 8:34:19 PM	TEXAS INSTRUMENTS	



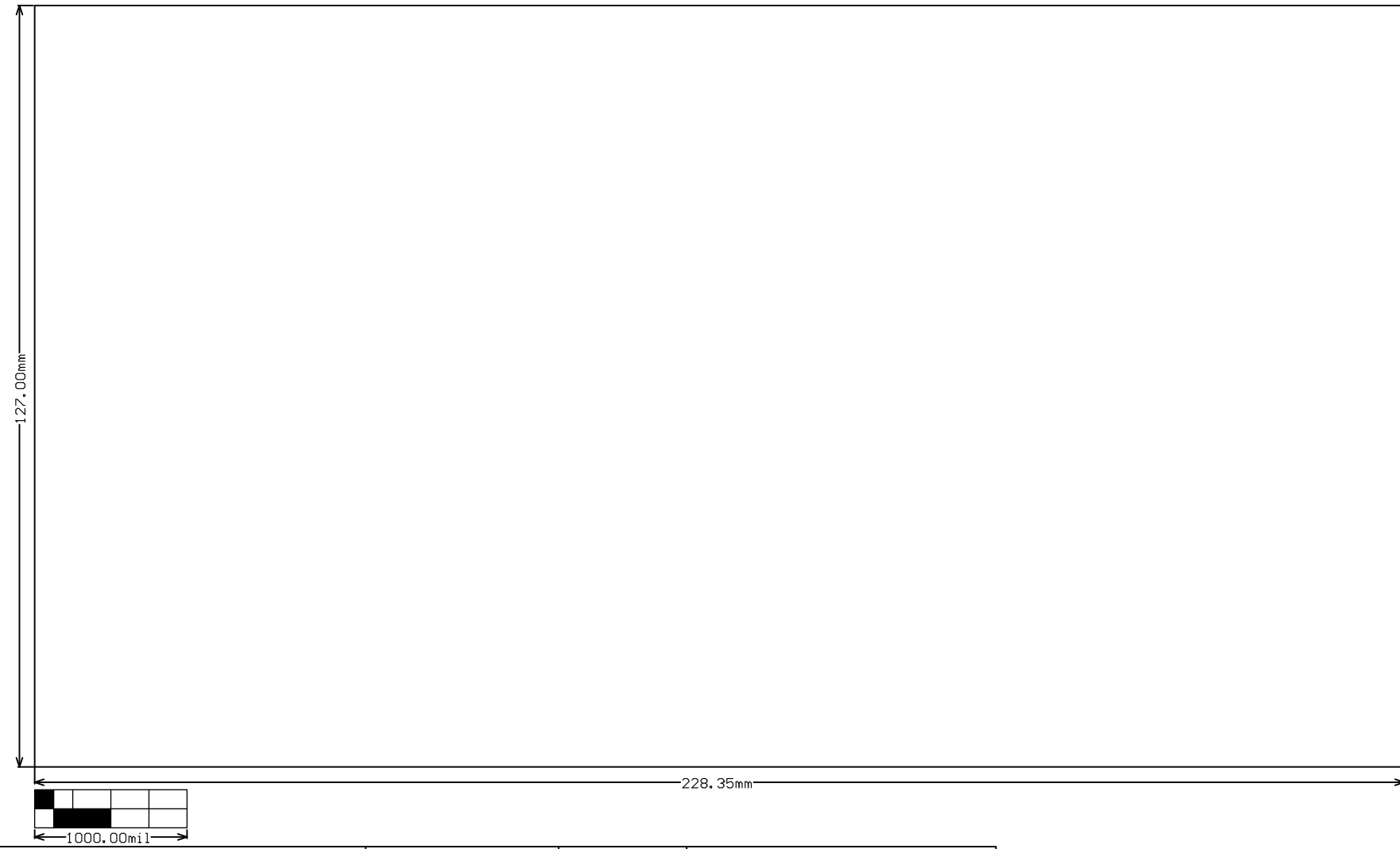
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = Bottom Overlay	TID #: TIDA-010087		
PLOT NAME = Bottom Overlay	GENERATED : 6/21/2023 8:34:19 PM		TEXAS INSTRUMENTS

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template
✳	623	11.81mil (0.300mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	<Mixed>
✳	817	16.00mil (0.406mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	<Mixed>
⊗	2	33.07mil (0.840mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c135h84
✳	12	35.43mil (0.900mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
⊗	6	38.50mil (0.978mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c148h98m154
▽	35	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
◇	2	50.00mil (1.270mm)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c3hn127m90
○	4	98.43mil (2.500mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
□	4	98.43mil (2.500mm)	PTH	Rectangle	Top Layer - Bottom Layer	Pad	Rounded	r1200_375h250_800r100
✳	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c800h320
■	8	270.00mil (6.858mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
	1517 Total							

Slot definitions : Routed Path Length = Calculated from tool start centre position to tool end centre position.
Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: TIDA-010087		
PLOT NAME = Drill Drawing	GENERATED : 6/21/2023 8:34:20 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: INDSYS-2081	REV: E2	SUN REV: Not in version control
LAYER NAME = M2 Board Dimensions	TID #: TIDA-010087		
PLOT NAME = Board Dimensions	GENERATED : 6/21/2023 8:34:25 PM	TEXAS INSTRUMENTS	

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